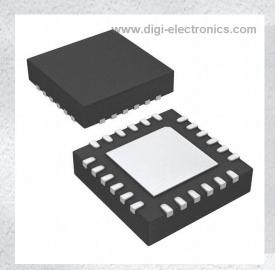


## 9DML0451AKILF Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number 9DML0451AKILF-DG

Manufacturer Renesas Electronics Corporation

Manufacturer Product Number 9DML0451AKILF

Description IC CLOCK PCIE 24VFQFPN

Detailed Description PCI Express (PCIe) Clock Multiplexer IC 200MHz 1 Ou

tput 24-QFN (4x4)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



## **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
9DML0451AKILF	Renesas Electronics Corporation
Series:	Product Status:
	Active
DiGi-Electronics Programmable:	PLL:
Not Verified	No
Main Purpose:	Input:
PCI Express (PCIe)	HCSL
Output:	Number of Circuits:
HCSL	1
Ratio - Input:Output:	Differential - Input:Output:
2:4	Yes/Yes
Frequency - Max:	Voltage - Supply:
200MHz	3.14V ~ 3.47V
Operating Temperature:	Mounting Type:
-40°C ~ 85°C	Surface Mount
Package / Case:	Supplier Device Package:
24-VFQFN Exposed Pad	24-QFN (4x4)
Base Product Number:	
9DML0451	

## **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

8542.39.0001



# 2:4 3.3V PCIe Gen1–6 Clock Mux

## 9DML0441 / 9DML0451

**DATASHEET** 

## **Description**

The 9DML0441 and 9DML0451 devices are 3.3V members of Renesas' Full-Featured PCIe family. They support PCIe Gen1–6 Common Clocked (CC), Separate Reference no Spread (SRnS), and Independent Reference (IR) clock architectures. The parts provide a choice of asynchronous or glitch-free, gapped-clock switching modes, and offer a choice of integrated output terminations for direct connection to  $85\Omega$  or  $100\Omega$  transmission lines.

## **Applications**

- Servers
- ATE
- Storage
- · Master/Slave applications

### **Output Features**

- Four 1-200MHz Low-Power HCSL (LP-HCSL) DIF pairs
- 9DML0441 default Zout =  $100\Omega$
- 9DML0451 default Zout =  $85\Omega$
- See AN-891 for easy termination to other logic levels

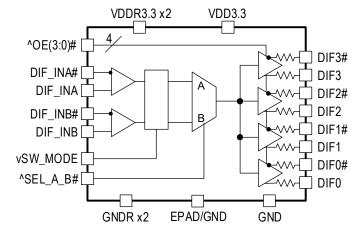
#### **Features**

- Direct connection to  $100\Omega$  (xx41) or  $85\Omega$  (xx51) transmission lines saves up to 16 resistors
- 79mW typical power consumption
- Spread Spectrum Clocking (SSC) compatible
- · OE# pins for each output
- HCSL-compatible differential inputs
- Selectable asynchronous or glitch-free, gapped-clock switching; allows the mux to be selected at power up even if both inputs are not running, then transition to glitch-free switching mode
- Space saving 4 × 4 mm 24-VFQFPN
- · Contact factory for customized versions

## **Key Specifications**

- PCIe Gen1-6 CC support
- PCIe Gen1-6 IR support
- Output-to-output skew < 50ps
- PCIe Gen6 additive jitter (CC) is < 0.02ps rms
- 12kHz–20MHz additive phase jitter 281fs rms typical at156.25MHz

## **Block Diagram**

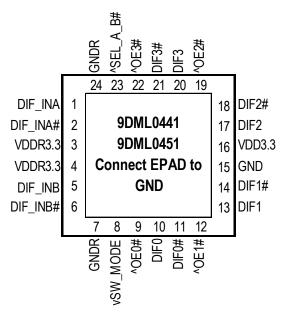


1

Note: Default resistors are internal on 41/51 devices.



## **Pin Configuration**



24-VFQFPN, 4 x 4 mm, 0.5mm pitch

^ prefix indicates internal pull-up resistor v prefix indicates internal pull-down resistor

## **Power Management Table**

OEx# Pin	DEx# Pin DIF IN		Fx
OLX# FIII	DIIIIV	True O/P	Comp. O/P
0	Running	Running	Running
1	Running	Low	Low

#### **Power Connections**

Pin Nu	ımber	Description			
VDD	GND				
3	24	Input A receiver analog			
4	7	Input B receiver analog			
16	15	DIF outputs			



## **Pin Descriptions**

Pin#	Pin Name	Туре	Pin Description
1	DIF_INA	IN	True input of differential clock
2	DIF_INA#	IN	Complement input of differential clock
3	VDDR3.3	PWR	Power supply for differential input clock (receiver). This VDD should be treated as an analog
	VDDING.0	1 7717	power rail and filtered appropriately. Nominally 3.3V.
4	VDDR3.3 PWR		Power supply for differential input clock (receiver). This VDD should be treated as an analog
			power rail and filtered appropriately. Nominally 3.3V.
5	DIF_INB	IN	True input of differential clock
6	DIF_INB#	IN	Complement input of differential clock
7	GNDR	GND	Analog ground pin for the differential input (receiver).
8	vSW_MODE	IN	Switch Mode. This pin selects either asynchronous or glitch-free, gapped clock switching of the mux. Use asynchronous mode if 0 or 1 of the input clocks is running. Glitch-free, gapped clock mode may be used if both input clocks are running. This pin has an internal pull down resistor.  0 = asynchronous switching mode 1 = glitch-free, gapped clock switching mode
9	^OE0#	IN	Active low input for enabling output 0. This pin has an internal pull-up resistor.  1 = disable output, 0 = enable output.
10	DIF0	OUT	Differential true clock output.
11	DIF0#	OUT	Differential complementary clock output.
12	^OE1#	IN	Active low input for enabling output 1. This pin has an internal pull-up resistor.  1 = disable output, 0 = enable output
13	DIF1	OUT	Differential true clock output.
14	DIF1#	OUT	Differential complementary clock output.
15	GND	GND	Ground pin.
16	VDD3.3	PWR	Power supply, nominally 3.3V
17	DIF2	OUT	Differential true clock output.
18	DIF2#	OUT	Differential complementary clock output.
19	^OE2#	IN	Active low input for enabling output 2. This pin has an internal pull-up resistor.  1 = disable output, 0 = enable output.
20	DIF3	OUT	Differential true clock output.
21	DIF3#	OUT	Differential complementary clock output.
22	^OE3#	IN	Active low input for enabling output 3. This pin has an internal pull-up resistor.  1 = disable output, 0 = enable output.
23	^SEL_A_B#	IN	Input to select differential input clock A or differential input clock B. This input has an internal pull-up resistor.  0 = Input B selected, 1 = Input A selected.
24	GNDR	GND	Analog ground pin for the differential input (receiver).
25	EPAD	GND	Connect to Ground.



## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the 9DML0441 / 9DML0451. These ratings, which are standard values for Renesas commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units	Notes
Supply Voltage	VDDx				4.6	V	1,2
Input Voltage	$V_{IN}$		-0.5		V <sub>DD</sub> +0.5	V	1,3
Input High Voltage, SMBus	V <sub>IHSMB</sub>	SMBus clock and data pins			3.9	V	1
Storage Temperature	Ts		-65		150	င့	1
Junction Temperature	Tj				125	°C	1
Input ESD protection	ESD prot	Human Body Model	2500			V	1

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

## **Electrical Characteristics-Clock Input Parameters**

T<sub>A</sub> = T<sub>AMB</sub>, Supply Voltages per normal operation Conditions, See Test Loads for Loading Conditions

Parameter	Symbol	Conditions Minimum		Typical	Maximum	Units	Notes
Input Common Mode Voltage - DIF_IN	V <sub>COM</sub>	Common Mode Input Voltage	150		900	mV	1
Input Swing - DIF_IN	$V_{SWING}$	Differential value	300			mV	1
Input Slew Rate - DIF_IN	dv/dt	Measured differentially	0.4		8	V/ns	1,2
Input Leakage Current	I <sub>IN</sub>	$V_{IN} = V_{DD}, V_{IN} = GND$	-5		5	uA	
Input Duty Cycle	d <sub>tin</sub>	Measurement from differential waveform	45		55	%	1
Input Jitter - Cycle to Cycle	$J_{DIFIn}$	Differential Measurement	0		125	ps	1

<sup>&</sup>lt;sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

## **Electrical Characteristics-Current Consumption**

T<sub>A</sub> = T<sub>AMB</sub>, Supply Voltages per normal operation Conditions, See Test Loads for Loading Conditions

Parameter	Symbol	Conditions Minim		Typical	Maximum	Units	Notes
Operating Supply Current	I <sub>DD</sub>	VDD, All outputs active at 100MHz		24	31	mA	
Powerdown Current	I <sub>DDPD</sub>	VDD, all outputs disabled		2	3	mA	1

<sup>&</sup>lt;sup>1</sup> Input clock stopped.

<sup>&</sup>lt;sup>2</sup>Operation under these Conditions is neither implied nor guaranteed.

<sup>&</sup>lt;sup>3</sup>Not to exceed 4.6V.

<sup>&</sup>lt;sup>2</sup> Slew rate measured through +/-75mV window centered around differential zero.



## Electrical Characteristics-Input/Supply/Common Parameters-Normal Operating Conditions

T<sub>A</sub> = T<sub>AMB</sub>, Supply Voltages per normal operation Conditions, See Test Loads for Loading Conditions

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units	Notes
Supply Voltage	VDDx	Supply voltage for core and analog	3.135	3.3	3.465	V	
Ambient Operating Temperature	$T_{AMB}$	Industrial range	-40	25	85	°C	
Input High Voltage	V <sub>IH</sub>	Single-ended inputs, except SMBus	0.75 V <sub>DD</sub>		V <sub>DD</sub> + 0.3	V	
Input Low Voltage	$V_{IL}$	Single-ended inputs, except SMBus	-0.3		0.25 V <sub>DD</sub>	V	
	I <sub>IN</sub>	Single-ended inputs, V <sub>IN</sub> = GND, V <sub>IN</sub> = VDD	-5		5	uA	
Input Current	I <sub>INP</sub>	Single-ended inputs $V_{IN} = 0 \text{ V}$ ; Inputs with internal pull-up resistors $V_{IN} = \text{VDD}$ ; Inputs with internal pull-down resistors	-50		50	uA	
Input Frequency	F <sub>ibyp</sub>		1		200	MHz	2
Pin Inductance	L <sub>pin</sub>				7	nH	1
	C <sub>IN</sub>	Logic Inputs, except DIF_IN	1.5		5	pF	1
Capacitance	C <sub>INDIF_IN</sub>	DIF_IN differential clock inputs	1.5		2.7	pF	1
	C <sub>OUT</sub>	Output pin capacitance			6	pF	1
Clk Stabilization	T <sub>STAB</sub>	From V <sub>DD</sub> Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock		0.74	1	ms	1,2
Input SS Modulation Frequency PCIe	f <sub>MODINPCle</sub>	Allowable Frequency for PCIe Applications (Triangular Modulation)	30	31.5	33	kHz	
Input SS Modulation Frequency non-PCle	f <sub>MODIN</sub>	Allowable Frequency for non-PCIe Applications (Triangular Modulation)	0		66	kHz	
OE# Latency	OE# Latency  tLATOE#  DIF start after OE# assertion  DIF stop after OE# deassertion		1	2	3	clocks	1,3
Tfall	t⊧	Fall time of single-ended control inputs	5		5	ns	2
Trise	t <sub>R</sub>	Rise time of single-ended control inputs			5	ns	2

Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> Control input must be monotonic from 20% to 80% of input swing.

<sup>&</sup>lt;sup>3</sup> Time from deassertion until outputs are > 200 mV.



## **Electrical Characteristics-DIF Low-Power HCSL Outputs**

T<sub>A</sub> = T<sub>AMB</sub>, Supply Voltages per normal operation Conditions, See Test Loads for Loading Conditions

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units	Notes
Slew rate	dV/dt	Scope averaging on, default settings	1.5	2.4	4	V/ns	1, 2, 3
Slew rate matching	∆dV/dt	Slew rate matching		8.1	20	%	1, 4
Voltage High	$V_{HIGH}$	Statistical measurement on single-ended signal using	660	783	850	mV	7
Voltage Low	V <sub>LOW</sub>	oscilloscope math function. (Scope averaging on)	-150	-24	150	1110	7
Maximum Voltage	VMaximum	Measurement on single ended signal using absolute value.		814	1150	mV	7
Minimum Voltage	VMinimum	(Scope averaging off)	-300	-66		IIIV	7
Crossing Voltage (abs)	Vcross_abs	Scope averaging off	250	368	550	mV	1, 5
Crossing Voltage (var)	Δ-Vcross	Scope averaging off		17	140	mV	1, 6

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

## Electrical Characteristics-Output Duty Cycle, Jitter, Skew and PLL Characteristics

T<sub>A</sub> = T<sub>AMB</sub>, Supply Voltages per normal operation Conditions, See Test Loads for Loading Conditions

Parameter	Symbol	Conditions		Typical	Maximum	Units	Notes
Duty Cycle Distortion	<b>t</b> DCD	Measured differentially, at 100MHz	0	0.2	0.7	%	1,3
Skew, Input to Output	t <sub>pd</sub>	V <sub>T</sub> = 50%	2637	3381	4273	ps	1
Skew, Output to Output	t <sub>sk3</sub>	V <sub>T</sub> = 50%		23	50	ps	1
Jitter, Cycle to cycle	фсус-сус	Additive Jitter			1	ps	1,2

<sup>&</sup>lt;sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> Measured from differential waveform

<sup>&</sup>lt;sup>3</sup> Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V. These are defaults for the 41/51 devices, alternate settings are available in the P1 device.

<sup>&</sup>lt;sup>4</sup> Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

<sup>&</sup>lt;sup>o</sup> Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>&</sup>lt;sup>6</sup> The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross\_Minimum/Maximum (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting Δ-Vcross to be smaller than Vcross absolute.

<sup>&</sup>lt;sup>7</sup> These are defaults for the 41/51 devices. They are factory adjustable in the P1 device.

<sup>&</sup>lt;sup>2</sup> Measured from differential waveform.

<sup>&</sup>lt;sup>3</sup> Duty cycle distortion is the difference in duty cycle between the output and the input clock.



#### Electrical Characteristics-Additive PCle Phase Jitter

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Limit	Units	Notes
	<sup>t</sup> jphPCIeG1-CC	PC le Gen 1 (2.5 GT/s)	1790	2905	4020	86000	fs (pk-pk)	1, 2
	tiphPCIeG2-CC	PCIe Gen 2 Hi Band (5.0 GT/s)	156	254	352	3100	fs (RMS)	1, 2
Additive PCIe Phase	jprir C1eGz-CC	PCIe Gen 2 Lo Band (5.0 GT/s)	72	81	91	3000	fs (RMS)	1, 2
Jitter (Common Clocked Architecture)	<sup>t</sup> jphPCIeG3-CC	PCIe Gen 3 (8.0 GT/s)	52	85	117	1000	fs (RMS)	1, 2
	<sup>t</sup> jphPCIeG4-CC	PCIe Gen 4 (16.0 GT/s)	52	85	117	500	fs (RMS)	1, 2, 3, 4
	<sup>t</sup> jphPCIeG5-CC	PC le Gen 5 (32.0 GT/s)	20	33	46	150	fs (RMS)	1, 2, 3, 5
	<sup>t</sup> jphPCIeG6-CC	PC le Gen 6 (64.0 GT/s)	12	20	27	100	fs (RMS)	1, 2, 3, 6
	<sup>t</sup> jphPCIeG1-IR	PCIe Gen 1 Band (5.0 GT/s)	n/a	n/a	n/a	n/a	fs (pk-pk)	1, 2, 7
	<sup>t</sup> jphPCIeG2-IR	PCIe Gen 2 Band (5.0 GT/s)	135	204	273	n/a	fs (RMS)	1, 2, 7
Additive PCIe Phase	<sup>t</sup> jphPCIeG3-IR	PCIe Gen 3 (8.0 GT/s)	52	81	109	n/a	fs (RMS)	1, 2, 7
Jitter (IR Architecture)	<sup>t</sup> jphPCIeG4-IR	PC le Gen 4 (16.0 GT/s)	54	83	112	n/a	fs (RMS)	1, 2, 7
	<sup>t</sup> jphPCIeG5-IR	PC le Gen 5 (32.0 GT/s)	15	23	32	n/a	fs (RMS)	1, 2, 7
Notes	<sup>t</sup> jphPCleG6-IR	PCIe Gen 6 (64.0 GT/s)	11	17	22	n/a	fs (RMS)	1, 2, 7

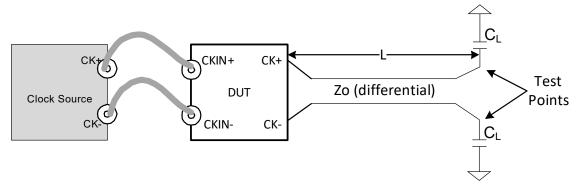
#### Notes:

- 1. The Refclk jitter is measured after applying the filter functions found in PCI Express Base Specification 6.2. See the Test Loads section of the data sheet for the exact measurement setup. The total Ref Clk jitter limits for each data rate are listed for convenience. The additive jitter may be subtracted from the limit using RSS subtraction to determine remaining margin.
- 2. Jitter measurements shall be made with a capture of at least 100,000 clock cycles captured by a real-time oscilloscope (RTO) with a sample rate of 20 GS/s or greater. Broadband oscilloscope noise must be minimized in the measurement. The measured PP jitter is used (no extrapolation) for RTO measurements. Alternately Jitter measurements may be used with a Phase Noise Analyzer (PNA) extending (flat) and integrating and folding the frequency content up to an offset from the carrier frequency of at least 200 MHz (at 300 MHz absolute frequency) below the Nyquist frequency. For PNA measurements for the 2.5 GT/s data ratem the RMS jitter is converted to peak to peak jitter using a multiplication factor of 8.83. In the case where real-time oscilloscope and PNA measurements have both been done and produce different results the RTO result must be used.
- 3. SSC spurs from the fundamental and harmonics are removed up to a cutoff frequency of 2 MHz taking care to minimize removal of any non-SSC content.
- 4. Note that 0.7 ps RMS is to be used in channel simulations to account for additional noise in a real system.
- 5. Note that 0.25 ps RMS is to be used in channel simulations to account for additional noise in a real system.
- 6. Note that 0.15 ps RMS is to be used in channel simulations to account for additional noise in a real system.
- 7. While the PCI Express Base Specification 6.2 provides the filters necessary to calculate IR jitter values, it does not provide specification limits, hence the n/a in the Limit column. IR values are informative only. In general, a clock operating in an IR system must be twice as good as a clock operating in a Common Clock system. For RMS values, twice as good is equivalent to dividing the CC value by  $\sqrt{2}$ .



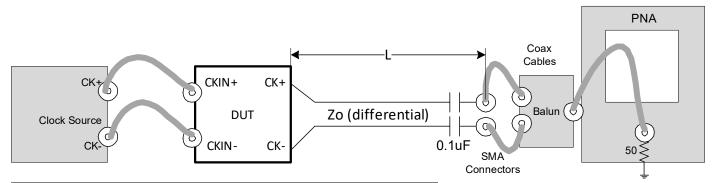
## **Test Loads**

#### **Test Load for AC/DC Measurements**



Clock Source	DUT	L (cm)	Differential Zo (ohms)	C <sub>L</sub> (pF)
SMA100B	9DML0451	12.7	85	2
SMA100B	9DML0441	12.7	100	2

#### **Test Load for Phase Jitter Measurements**



Clock Source	DUT	L (cm)	Differential Zo (ohms)
SMA100B	9DML0451	25.4	85
SMA100B	9DML0441	25.4	100

#### **Alternate HCSL Terminations**

Device	Differential Zo (Ω)	Rs (Ω)
9DML0441	85	N/A
9DML0441	100	None needed
9DML0451	85	None needed
9DML0451	100	7.5

## **Alternate Terminations**

The 9DML family can easily drive LVPECL, LVDS, and CML logic. See <u>"AN-891 Driving LVPECL, LVDS, and CML Logic with "Universal" Low-Power HCSL Outputs"</u> for details.



## **Marking Diagrams**





#### Notes:

- 1. Line 1: "LOT" is the lot sequence number.
- 2. Line 2: truncated part number.
- 3. Line 3: "YYWW" is the digits of the year and work-week that the part was assembled.

#### **Thermal Characteristics**

Parameter	Symbol	Conditions	PKG	Typical VALUE	Units	Notes
	$\theta_{JC}$	Junction to Case	NLG24	42	°C/W	1
	$\theta_{Jb}$	Junction to Base		2.4	°C/W	1
Thermal Resistance	$\theta_{JA0}$	Junction to Air, still air		39	°C/W	1
Thermal Resistance	$\theta_{JA1}$	Junction to Air, 1 m/s air flow		33	°C/W	1
	$\theta_{JA3}$	Junction to Air, 3 m/s air flow		28	°C/W	1
	$\theta_{JA5}$	Junction to Air, 5 m/s air flow		27	°C/W	1

<sup>&</sup>lt;sup>1</sup> EPAD soldered to board.

## **Package Outline Drawings**

The package outline drawings are appended at the end of this document and are accessible from the link below. The package information is the most current data available.

24-VFQFPN Package Outline Drawing

## **Ordering Information**

Part / Order Number	Notes	ShippingPackaging	Package	Temperature
9DML0441AKILF	100Ω	Trays	24-VFQFPN	-40 to +85° C
9DML0441AKILFT	10022	Tape and Reel	24-VFQFPN	-40 to +85° C
9DML0451AKILF	85Ω	Trays	24-VFQFPN	-40 to +85° C
9DML0451AKILFT	0312	Tape and Reel	24-VFQFPN	-40 to +85° C

<sup>&</sup>quot;LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

<sup>&</sup>quot;A" is the device revision designator (will not correlate with the datasheet revision).



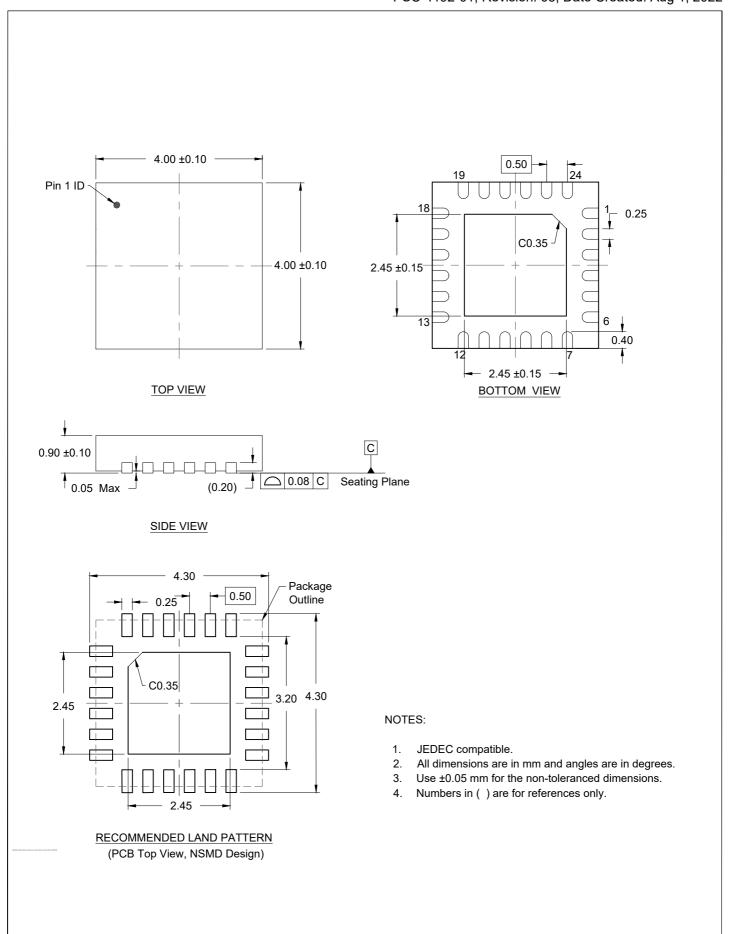
## **Revision History**

Date	Description
	Updated Table 7 Electrical Characteristics - Additive PCle Phase Jitter.
December 12, 2024	2. Changed all references of Gen1-5 to Gen1-6.
	3. Updated Key Specifications on page 1.
December 2, 2022	Updated POD link.
May 22, 2019	Added PCle Gen5 parameters to electrical tables
Iviay 22, 2019	2. Removed 'P' devices from data sheet.
	Minor updates to electrical tables.
August 27, 2018	2. Updated front page text.
	3. Updated block diagram.
June 6, 2016	1. Updated leakage current spec for inputs with pull/up/down to +/-50μA.
	Updated electrical tables with characterization data.
	3. Update Front page text.
	4. Updated ordering information.
	5. Move to Final.





Package Code:NLG24P1 24-VFQFPN 4.0 x 4.0 x 0.9 mm Body, 0.5mm Pitch PSC-4192-01, Revision: 05, Date Created: Aug 1, 2022



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